

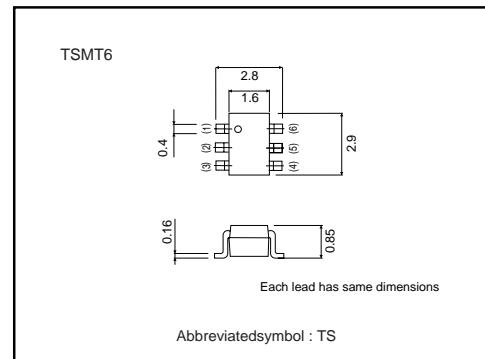
DC-DC Converter (-20V, -3.0A)

RTQ030P02

●Features

- 1) Low On-resistance.(110mΩ at 2.5V)
- 2) High Power Package.
- 3) High speed switching.
- 4) Low voltage drive.(2.5V)

●External dimensions (Units : mm)



●Applications

DC-DC converter

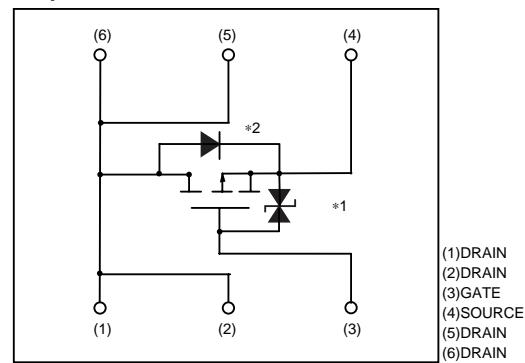
●Structure

Silicon P-channel
MOSFET

●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
RTQ030P02	○	

●Equivalent circuit



●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-source voltage	V _{DSS}	-20	V
Gate-source voltage	V _{GSS}	±12	V
Drain current	Continuous	I _D	±3
	Pulsed	I _{DP}	±12
Source current (Body diode)	Continuous	I _S	-1
	Pulsed	I _{SP}	-4
Total power dissipation	P _D	1.25	W ²
Channel temperature	T _{ch}	150	°C
Range of Storage temperature	T _{stg}	-55~+150	°C

*1 P_W≤10μs, Duty cycle≤1%

*2 Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions	
Gate-source leakage	I _{GS}	-	-	±10	μA	V _{GS} =±12V, V _{DS} =0V	
Drain-source breakdown voltage	V _{(BR)DSS}	-20	-	-	V	I _D =-1mA, V _{GS} =0V	
Zero gate voltage drain current	I _{DSS}	-	-	-1	μA	V _{DS} =-20V, V _{GS} =0V	
Gate threshold voltage	V _{GS(th)}	-0.7	-	-2.0	V	V _{DS} =-10V, I _D =-1mA	
Static drain-source on-state resistance	R _{DS(on)} [*]	-	60	80	mΩ	I _D =-3A, V _{GS} =-4.5V	
		-	65	90	mΩ	I _D =-3A, V _{GS} =-4V	
		-	110	150	mΩ	I _D =-1.5A, V _{GS} =-2.5V	
Forward transfer admittance	Y _{fs} [*]	2.0	-	-	S	V _{DS} =-10V, I _D =-1.5A	
Input capacitance	C _{iss}	-	800	-	pF	V _{DS} =-10V, V _{GS} =0V f=1MHz	
Output capacitance	C _{oss}	-	150	-	pF		
Reverse transfer capacitance	C _{rss}	-	100	-	pF		
Turn-on delay time	t _{d(on)} [*]	-	15	-	ns	I _D =-1.5A V _{DD} =-15V V _{GS} =-4.5V R _L =10Ω R _{GS} =10Ω	
Rise time	t _r [*]	-	27	-	ns		
Turn-off delay time	t _{d(off)} [*]	-	50	-	ns		
Fall time	t _f [*]	-	20	-	ns		
Total gate charge	Q _G	-	9.0	-	nC	V _{DD} =-15V V _{GS} =-4.5V I _D =-3A	
Gate-source charge	Q _{GS}	-	1.6	-	nC		
Gate-drain charge	Q _{GD}	-	4.6	-	nC		
*PULSED							
Body diode characteristics (source-drain characteristics)							
Forward voltage	V _{SD}	-	-	-1.2	V	I _S =-1A, V _{GS} =0V	

Transistor

●Electrical characteristic curves

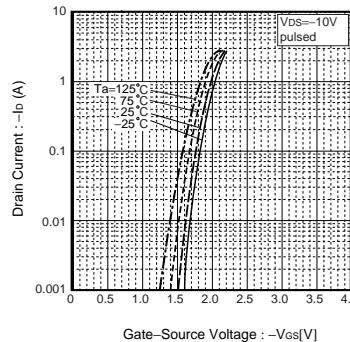


Fig.1 Typical Transfer Characteristics

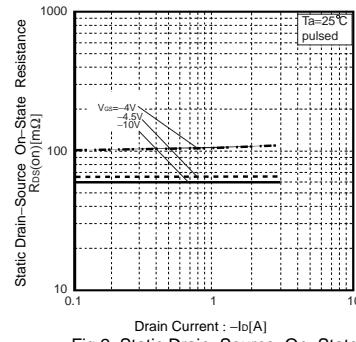


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

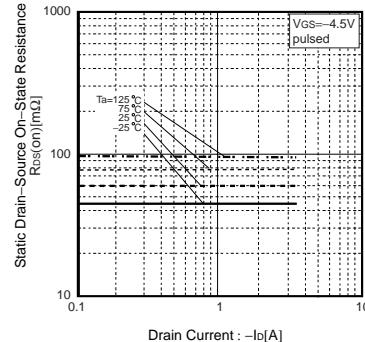


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

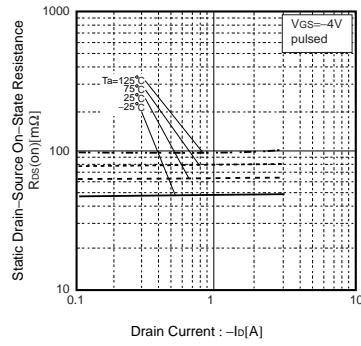


Fig.4 Static Drain-Source On-State Resistance vs. Drain-Current

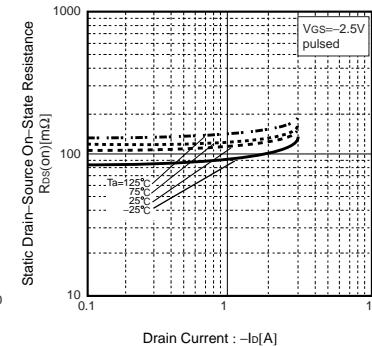


Fig.5 Static Drain-Source On-State Resistance vs. Drain-Current

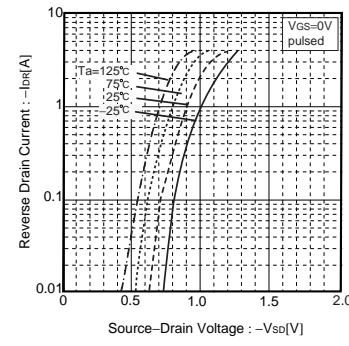


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

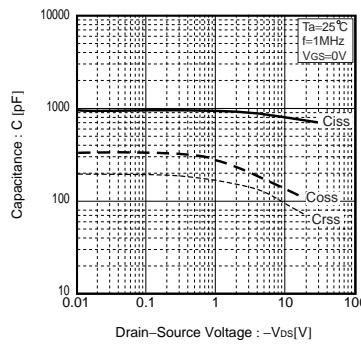


Fig.7 Typical Capacitance vs. Drain-Source Voltage

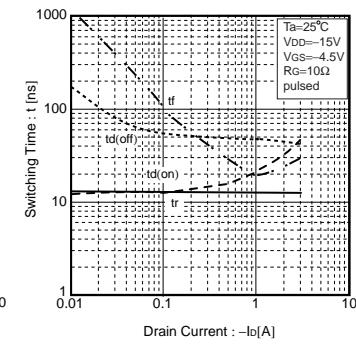


Fig.8 Switching Characteristics

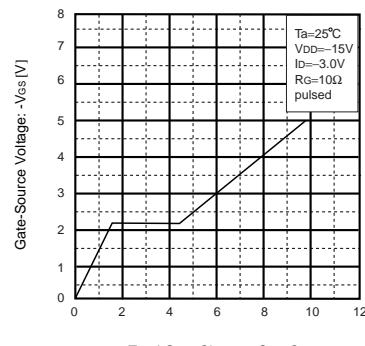


Fig.9 Dynamic Input Characteristics

●Measurement circuits

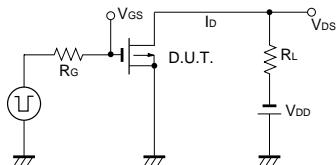


Fig.10 Switching Time Measurement Circuit

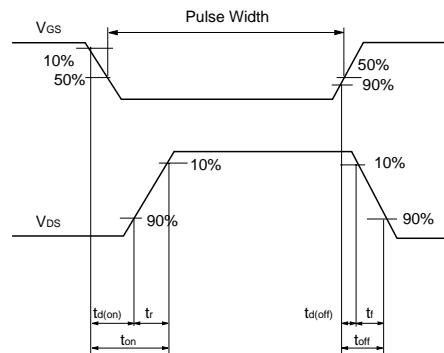


Fig.11 Switching Waveforms

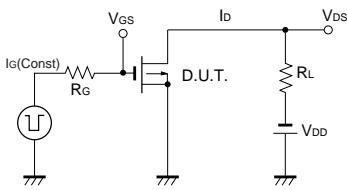


Fig.12 Gate Charge Measurement Circuit

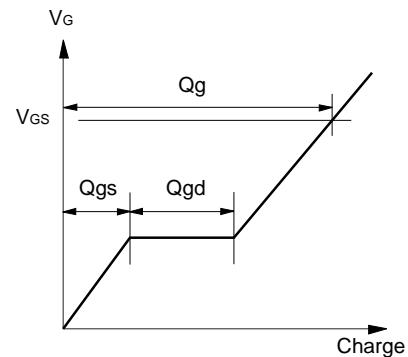


Fig.13 Gate Charge Waveforms

Appendix

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Appendix1-Rev1.0